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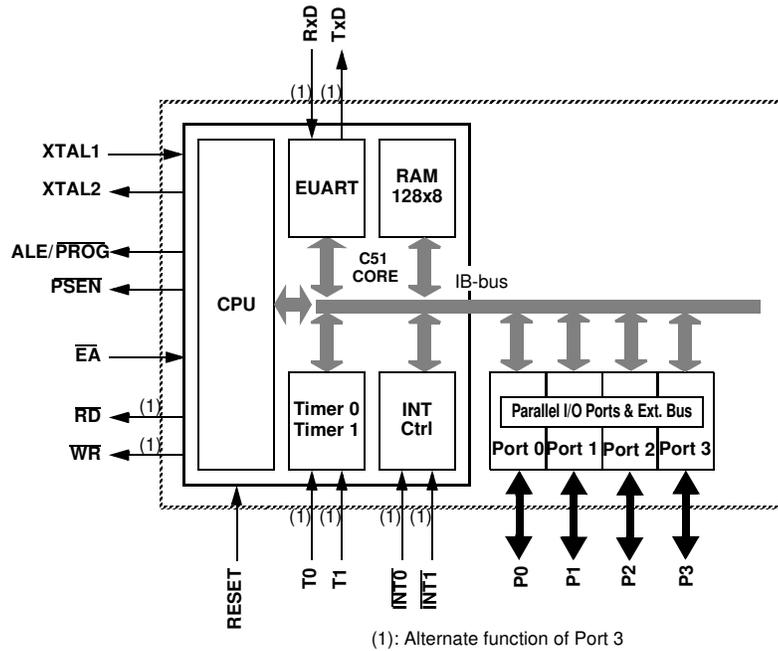
"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	30/20MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIL
Purchase URL	https://www.e-xfl.com/product-detail/atmel/at80c31x2-3csul

2. Block Diagram





EA	31	35	29	I	External Access Enable: \overline{EA} must be externally held low to enable the device to fetch code from external program memory locations.
XTAL1	19	21	15	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL2	18	20	14	O	Crystal 2: Output from the inverting oscillator amplifier



9. TS80C31X2 Serial I/O Port

The serial I/O port in the TS80C31X2 is compatible with the serial I/O port in the 80C31. It provides both synchronous and asynchronous communication modes. It operates as an Universal Asynchronous Receiver and Transmitter (UART) in three full-duplex modes (Modes 1, 2 and 3). Asynchronous transmission and reception can occur simultaneously and at different baud rates

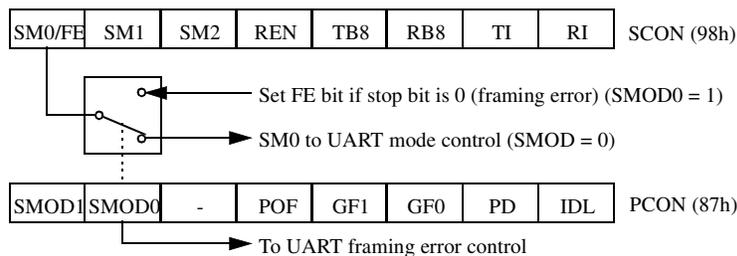
Serial I/O port includes the following enhancements:

- Framing error detection
- Automatic address recognition

9.1 Framing Error Detection

Framing bit error detection is provided for the three asynchronous modes (modes 1, 2 and 3). To enable the framing bit error detection feature, set SMOD0 bit in PCON register (See Figure 9-1).

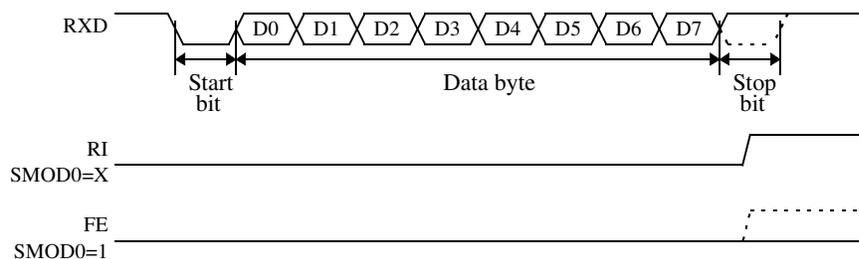
Figure 9-1. Framing Error Block Diagram



When this feature is enabled, the receiver checks each incoming data frame for a valid stop bit. An invalid stop bit may result from noise on the serial lines or from simultaneous transmission by two CPUs. If a valid stop bit is not found, the Framing Error bit (FE) in SCON register (See Table 9-3.) bit is set.

Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 9-2. and Figure 9-3.).

Figure 9-2. UART Timings in Mode 1



Slave C: SADDR 1111 0010b
 SADEN 1111 1101b
 Given 1111 00X1b

The SADEN byte is selected so that each slave may be addressed separately.
 For slave A, bit 0 (the LSB) is a don't-care bit; for slaves B and C, bit 0 is a 1. To communicate with slave A only, the master must send an address where bit 0 is clear (e.g. 1111 0000b).
 For slave A, bit 1 is a 1; for slaves B and C, bit 1 is a don't care bit. To communicate with slaves B and C, but not slave A, the master must send an address with bits 0 and 1 both set (e.g. 1111 0011b).
 To communicate with slaves A, B and C, the master must send an address with bit 0 set, bit 1 clear, and bit 2 clear (e.g. 1111 0001b).

9.4 Broadcast Address

A broadcast address is formed from the logical OR of the SADDR and SADEN registers with zeros defined as don't-care bits, e.g.:

 SADDR 0101 0110b
 SADEN 1111 1100b
 Broadcast =SADDR OR SADEN 1111 111Xb

The use of don't-care bits provides flexibility in defining the broadcast address, however in most applications, a broadcast address is FFh. The following is an example of using broadcast addresses:

Slave A: SADDR 1111 0001b
 SADEN 1111 1010b
 Broadcast 1111 1X11b,

 Slave B: SADDR 1111 0011b
 SADEN 1111 1001b
 Broadcast 1111 1X11b,

 Slave C: SADDR= 1111 0010b
 SADEN 1111 1101b
 Broadcast 1111 1111b

For slaves A and B, bit 2 is a don't care bit; for slave C, bit 2 is set. To communicate with all of the slaves, the master must send an address FFh. To communicate with slaves A and B, but not slave C, the master can send an address FBh.

9.5 Reset Addresses

On reset, the SADDR and SADEN registers are initialized to 00h, i.e. the given and broadcast addresses are XXXX XXXXb (all don't-care bits). This ensures that the serial port will reply to any address, and so, that it is backwards compatible with the 80C51 microcontrollers that do not support automatic address recognition.

Table 9-1. SADEN - Slave Address Mask Register (B9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b
 Not bit addressable

A low-priority interrupt can be interrupted by a high priority interrupt, but not by another low-priority interrupt. A high-priority interrupt can't be interrupted by any other interrupt source.

If two interrupt requests of different priority levels are received simultaneously, the request of higher priority level is serviced. If interrupt requests of the same priority level are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence.

Table 10-2. IE Register -- IE - Interrupt Enable Register (A8h)

7	6	5	4	3	2	1	0
EA	-	-	ES	ET1	EX1	ET0	EX0
Bit Number	Bit Mnemonic	Description					
7	EA	Enable All interrupt bit Clear to disable all interrupts. Set to enable all interrupts. If EA=1, each interrupt source is individually enabled or disabled by setting or clearing its own interrupt enable bit.					
6	-	Reserved The value read from this bit is indeterminate. Do not set this bit.					
5	-	Reserved The value read from this bit is indeterminate. Do not set this bit.					
4	ES	Serial port Enable bit Clear to disable serial port interrupt. Set to enable serial port interrupt.					
3	ET1	Timer 1 overflow interrupt Enable bit Clear to disable timer 1 overflow interrupt. Set to enable timer 1 overflow interrupt.					
2	EX1	External interrupt 1 Enable bit Clear to disable external interrupt 1. Set to enable external interrupt 1.					
1	ET0	Timer 0 overflow interrupt Enable bit Clear to disable timer 0 overflow interrupt. Set to enable timer 0 overflow interrupt.					
0	EX0	External interrupt 0 Enable bit Clear to disable external interrupt 0. Set to enable external interrupt 0.					

Reset Value = 0XX0 0000b

Bit addressable

Table 10-4. IPH Register -- IPH - Interrupt Priority High Register (B7h)

7	6	5	4	3	2	1	0															
-	-	-	PSH	PT1H	PX1H	PT0H	PX0H															
Bit Number	Bit Mnemonic	Description																				
7	-	Reserved The value read from this bit is indeterminate. Do not set this bit.																				
6	-	Reserved The value read from this bit is indeterminate. Do not set this bit.																				
5	-	Reserved The value read from this bit is indeterminate. Do not set this bit.																				
4	PSH	Serial port Priority High bit <table border="1"> <thead> <tr> <th>PSH</th> <th>PS</th> <th>Priority Level</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>Lowest</td> </tr> <tr> <td>0</td> <td>1</td> <td></td> </tr> <tr> <td>1</td> <td>0</td> <td></td> </tr> <tr> <td>1</td> <td>1</td> <td>Highest</td> </tr> </tbody> </table>						PSH	PS	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PSH	PS	Priority Level																				
0	0	Lowest																				
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PT1H	PT1	Priority Level																				
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1	0																					
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0	1																					
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PX0H	PX0	Priority Level																				
0	0	Lowest																				
0	1																					
1	0																					
1	1	Highest																				

Reset Value = XXX0 0000b

Not bit addressable

13. Power-Off Flag

The power-off flag allows the user to distinguish between a “cold start” reset and a “warm start” reset.

A cold start reset is the one induced by V_{CC} switch-on. A warm start reset occurs while V_{CC} is still applied to the device and could be generated for example by an exit from power-down.

The power-off flag (POF) is located in PCON register (See Table 13-1.). POF is set by hardware when V_{CC} rises from 0 to its nominal voltage. The POF can be set or cleared by software allowing the user to determine the type of reset.

The POF value is only relevant with a V_{cc} range from 4.5V to 5.5V. For lower V_{cc} value, reading POF bit will return indeterminate value.

Table 13-1. PCON Register -- PCON - Power Control Register (87h)

7	6	5	4	3	2	1	0
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL
Bit Number	Bit Mnemonic	Description					
7	SMOD1	Serial port Mode bit 1 Set to select double baud rate in mode 1, 2 or 3.					
6	SMOD0	Serial port Mode bit 0 Clear to select SM0 bit in SCON register. Set to select FE bit in SCON register.					
5	-	Reserved The value read from this bit is indeterminate. Do not set this bit.					
4	POF	Power-Off Flag Clear to recognize next reset type. Set by hardware when V_{CC} rises from 0 to its nominal voltage. Can also be set by software.					
3	GF1	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.					
2	GF0	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.					
1	PD	Power-Down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.					
0	IDL	Idle mode bit Clear by hardware when interrupt or reset occurs. Set to enter idle mode.					

Reset Value = 00X1 0000b

Not bit addressable

14. Electrical Characteristics

14.1 Absolute Maximum Ratings ⁽¹⁾

Ambiant Temperature Under Bias:

C = commercial 0°C to 70°C

I = industrial -40°C to 85°C

Storage Temperature -65°C to + 150°C

Voltage on V_{CC} to V_{SS} -0.5 V to + 7 V

Voltage on V_{PP} to V_{SS} -0.5 V to + 13 V

Voltage on Any Pin to V_{SS} -0.5 V to V_{CC} + 0.5 V

Power Dissipation 1 W⁽²⁾

- Note:
1. Stresses at or above those listed under “ Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
 2. This value is based on the maximum allowable die temperature and the thermal resistance of the package.

14.2 Power consumption measurement

Since the introduction of the first C51 devices, every manufacturer made operating Icc measurements under reset, which made sense for the designs where the CPU was running under reset. In Atmel Wireless & Microcontrollers new devices, the CPU is no more active during reset, so the power consumption is very low but is not really representative of what will happen in the customer system. That’s why, while keeping measurements under Reset, Atmel Wireless & Microcontrollers presents a new way to measure the operating Icc:

Using an internal test ROM, the following code is executed:

Label: SJMP Label (80 FE)

Ports 1, 2, 3 are disconnected, Port 0 is tied to FFh, EA = Vcc, RST = Vss, XTAL2 is not connected and XTAL1 is driven by the clock.

This is much more representative of the real operating Icc.

14.3 DC Parameters for Standard Voltage

$T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$; $V_{SS} = 0\text{ V}$; $V_{CC} = 5\text{ V} \pm 10\%$; $F = 0$ to 40 MHz .

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$; $V_{SS} = 0\text{ V}$; $V_{CC} = 5\text{ V} \pm 10\%$; $F = 0$ to 40 MHz .

Table 14-1. DC Parameters in Standard Voltage

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{IL}	Input Low Voltage	-0.5		$0.2 V_{CC} - 0.1$	V	
V_{IH}	Input High Voltage except XTAL1, RST	$0.2 V_{CC} + 0.9$		$V_{CC} + 0.5$	V	
V_{IH1}	Input High Voltage, XTAL1, RST	$0.7 V_{CC}$		$V_{CC} + 0.5$	V	
V_{OL}	Output Low Voltage, ports 1, 2, 3 ⁽⁶⁾			0.3	V	$I_{OL} = 100\ \mu\text{A}^{(4)}$ $I_{OL} = 1.6\ \text{mA}^{(4)}$ $I_{OL} = 3.5\ \text{mA}^{(4)}$
				0.45	V	
				1.0	V	
V_{OL1}	Output Low Voltage, port 0 ⁽⁶⁾			0.3	V	$I_{OL} = 200\ \mu\text{A}^{(4)}$ $I_{OL} = 3.2\ \text{mA}^{(4)}$ $I_{OL} = 7.0\ \text{mA}^{(4)}$
				0.45	V	
				1.0	V	
V_{OL2}	Output Low Voltage, ALE, $\overline{\text{PSEN}}$			0.3	V	$I_{OL} = 100\ \mu\text{A}^{(4)}$ $I_{OL} = 1.6\ \text{mA}^{(4)}$ $I_{OL} = 3.5\ \text{mA}^{(4)}$
				0.45	V	
				1.0	V	
V_{OH}	Output High Voltage, ports 1, 2, 3	$V_{CC} - 0.3$			V	$I_{OH} = -10\ \mu\text{A}$ $I_{OH} = -30\ \mu\text{A}$ $I_{OH} = -60\ \mu\text{A}$ $V_{CC} = 5\text{ V} \pm 10\%$
		$V_{CC} - 0.7$			V	
		$V_{CC} - 1.5$			V	
V_{OH1}	Output High Voltage, port 0	$V_{CC} - 0.3$			V	$I_{OH} = -200\ \mu\text{A}$ $I_{OH} = -3.2\ \text{mA}$ $I_{OH} = -7.0\ \text{mA}$ $V_{CC} = 5\text{ V} \pm 10\%$
		$V_{CC} - 0.7$			V	
		$V_{CC} - 1.5$			V	
V_{OH2}	Output High Voltage, ALE, $\overline{\text{PSEN}}$	$V_{CC} - 0.3$			V	$I_{OH} = -100\ \mu\text{A}$ $I_{OH} = -1.6\ \text{mA}$ $I_{OH} = -3.5\ \text{mA}$ $V_{CC} = 5\text{ V} \pm 10\%$
		$V_{CC} - 0.7$			V	
		$V_{CC} - 1.5$			V	
R_{RST}	RST Pulldown Resistor	50	90 ⁽⁵⁾	200	k Ω	
I_{IL}	Logical 0 Input Current ports 1, 2 and 3			-50	μA	$V_{in} = 0.45\text{ V}$
I_{LI}	Input Leakage Current			± 10	μA	$0.45\text{ V} < V_{in} < V_{CC}$
I_{TL}	Logical 1 to 0 Transition Current, ports 1, 2, 3			-650	μA	$V_{in} = 2.0\text{ V}$
C_{IO}	Capacitance of I/O Buffer			10	pF	$F_c = 1\text{ MHz}$ $T_A = 25^\circ\text{C}$
I_{PD}	Power Down Current		20 ⁽⁵⁾	50	μA	$2.0\text{ V} < V_{CC} < 5.5\text{ V}^{(3)}$
I_{CC} under RESET	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			1 + 0.4 Freq (MHz) @12MHz 5.8 @16MHz 7.4	mA	$V_{CC} = 5.5\text{ V}^{(1)}$
I_{CC} operating	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			3 + 0.6 Freq (MHz) @12MHz 10.2 @16MHz 12.6	mA	$V_{CC} = 5.5\text{ V}^{(8)}$

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
I_{CC} idle	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			0.25+0.3 Freq (MHz) @12MHz 3.9 @16MHz 5.1	mA	$V_{CC} = 5.5 V^{(2)}$

14.4 DC Parameters for Low Voltage

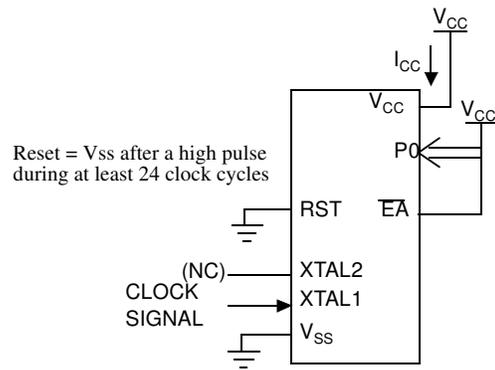
$T_A = 0^\circ C$ to $+70^\circ C$; $V_{SS} = 0 V$; $V_{CC} = 2.7 V$ to $5.5 V \pm 10\%$; $F = 0$ to $30 MHz$.

$T_A = -40^\circ C$ to $+85^\circ C$; $V_{SS} = 0 V$; $V_{CC} = 2.7 V$ to $5.5 V \pm 10\%$; $F = 0$ to $30 MHz$.

Table 14-2. DC Parameters for Low Voltage

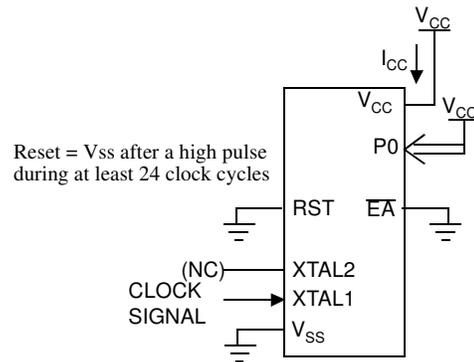
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{IL}	Input Low Voltage	-0.5		$0.2 V_{CC} - 0.1$	V	
V_{IH}	Input High Voltage except XTAL1, RST	$0.2 V_{CC} + 0.9$		$V_{CC} + 0.5$	V	
V_{IH1}	Input High Voltage, XTAL1, RST	$0.7 V_{CC}$		$V_{CC} + 0.5$	V	
V_{OL}	Output Low Voltage, ports 1, 2, 3 ⁽⁶⁾			0.45	V	$I_{OL} = 0.8 mA^{(4)}$
V_{OL1}	Output Low Voltage, port 0, ALE, \overline{PSEN} ⁽⁶⁾			0.45	V	$I_{OL} = 1.6 mA^{(4)}$
V_{OH}	Output High Voltage, ports 1, 2, 3	$0.9 V_{CC}$			V	$I_{OH} = -10 \mu A$
V_{OH1}	Output High Voltage, port 0, ALE, \overline{PSEN}	$0.9 V_{CC}$			V	$I_{OH} = -40 \mu A$
I_{IL}	Logical 0 Input Current ports 1, 2 and 3			-50	μA	$V_{in} = 0.45 V$
I_{LI}	Input Leakage Current			± 10	μA	$0.45 V < V_{in} < V_{CC}$
I_{TL}	Logical 1 to 0 Transition Current, ports 1, 2, 3			-650	μA	$V_{in} = 2.0 V$
R_{RST}	RST Pulldown Resistor	50	90 ⁽⁵⁾	200	k Ω	
CIO	Capacitance of I/O Buffer			10	pF	$F_c = 1 MHz$ $T_A = 25^\circ C$
I_{PD}	Power Down Current		20 ⁽⁵⁾ 10 ⁽⁵⁾	50 30	μA	$V_{CC} = 2.0 V$ to $5.5 V^{(3)}$ $V_{CC} = 2.0 V$ to $3.3 V^{(3)}$
I_{CC} under RESET	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			1 + 0.2 Freq (MHz) @12MHz 3.4 @16MHz 4.2	mA	$V_{CC} = 3.3 V^{(1)}$
I_{CC} operating	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			1 + 0.3 Freq (MHz) @12MHz 4.6 @16MHz 5.8	mA	$V_{CC} = 3.3 V^{(8)}$
I_{CC} idle	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			0.15 Freq (MHz) + 0.2 @12MHz 2 @16MHz 2.6	mA	$V_{CC} = 3.3 V^{(2)}$

Note: 1. I_{CC} under reset is measured with all output pins disconnected; XTAL1 driven with T_{CLCH} , $T_{CHCL} = 5 ns$ (see Figure 14-5.), $V_{IL} = V_{SS} + 0.5 V$,



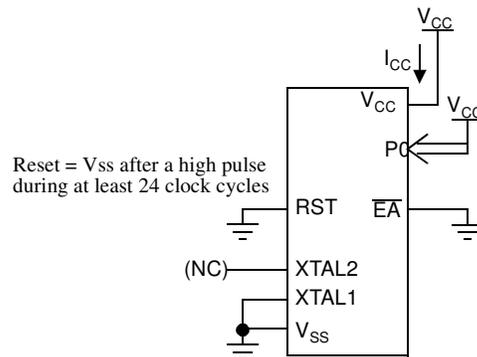
All other pins are disconnected.

Figure 14-2. Operating I_{CC} Test Condition



All other pins are disconnected.

Figure 14-3. I_{CC} Test Condition, Idle Mode



All other pins are disconnected.

Figure 14-4. I_{CC} Test Condition, Power-Down Mode

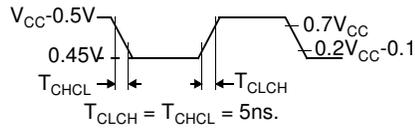


Figure 14-5. Clock Signal Waveform for I_{CC} Tests in Active and Idle Modes

14.5 AC Parameters

14.5.1 Explanation of the AC Symbols

Each timing symbol has 5 characters. The first character is always a “T” (stands for time). The other characters, depending on their positions, stand for the name of a signal or the logical status of that signal. The following is a list of all the characters and what they stand for.

Example: T_{AVLL} = Time for Address Valid to ALE Low.

T_{LLPL} = Time for ALE Low to \overline{PSEN} Low.

$T_A = 0$ to $+70^\circ\text{C}$ (commercial temperature range); $V_{SS} = 0$ V; $V_{CC} = 5$ V \pm 10%; -M and -V ranges.
 $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (industrial temperature range); $V_{SS} = 0$ V; $V_{CC} = 5$ V \pm 10%; -M and -V ranges.

$T_A = 0$ to $+70^\circ\text{C}$ (commercial temperature range); $V_{SS} = 0$ V; 2.7 V $< V_{CC} < 5.5$ V; -L range.

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (industrial temperature range); $V_{SS} = 0$ V; 2.7 V $< V_{CC} < 5.5$ V; -L range.

Table 14-3. gives the maximum applicable load capacitance for Port 0, Port 1, 2 and 3, and ALE and \overline{PSEN} signals. Timings will be guaranteed if these capacitances are respected. Higher capacitance values can be used, but timings will then be degraded.

Table 14-3. Load Capacitance versus speed range, in pF

	-M	-V	-L
Port 0	100	50	100
Port 1, 2, 3	80	50	80
ALE / \overline{PSEN}	100	30	100

Table 8-5., Table 8-8. and Table 8-11. give the description of each AC symbols.

Table 14-6., Table 14-9. and Table 14-12. give for each range the AC parameter.

14.5.2 External Program Memory Read Cycle

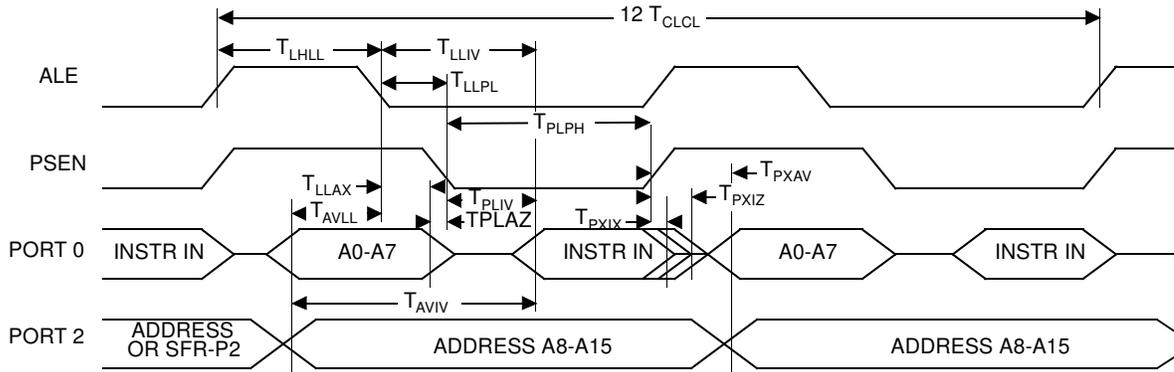


Figure 14-6. External Program Memory Read Cycle

Table 14-8. External Data Memory Characteristics

Symbol	Parameter
T _{RLRH}	\overline{RD} Pulse Width
T _{WLWH}	\overline{WR} Pulse Width
T _{RLDV}	\overline{RD} to Valid Data In
T _{RHDX}	Data Hold After \overline{RD}
T _{RHDZ}	Data Float After \overline{RD}
T _{LLDV}	ALE to Valid Data In
T _{AVDV}	Address to Valid Data In
T _{LLWL}	ALE to \overline{WR} or \overline{RD}
T _{AVWL}	Address to \overline{WR} or \overline{RD}
T _{QVWX}	Data Valid to \overline{WR} Transition
T _{QVWH}	Data set-up to \overline{WR} High
T _{WHQX}	Data Hold After \overline{WR}
T _{RLAZ}	\overline{RD} Low to Address Float
T _{WHLH}	\overline{RD} or \overline{WR} High to ALE high

Table 14-10. AC Parameters for a Variable Clock: derating formula

Symbol	Type	Standard Clock	X2 Clock	-M	-V	-L	Units
T_{RLRH}	Min	6 T - x	3 T - x	20	15	25	ns
T_{WLWH}	Min	6 T - x	3 T - x	20	15	25	ns
T_{RLDV}	Max	5 T - x	2.5 T - x	25	23	30	ns
T_{RHDx}	Min	x	x	0	0	0	ns
T_{RHDz}	Max	2 T - x	T - x	20	15	25	ns
T_{LLDV}	Max	8 T - x	4T - x	40	35	45	ns
T_{AVDV}	Max	9 T - x	4.5 T - x	60	50	65	ns
T_{LLWL}	Min	3 T - x	1.5 T - x	25	20	30	ns
T_{LLWL}	Max	3 T + x	1.5 T + x	25	20	30	ns
T_{AVWL}	Min	4 T - x	2 T - x	25	20	30	ns
T_{QVWX}	Min	T - x	0.5 T - x	15	10	20	ns
T_{QVWH}	Min	7 T - x	3.5 T - x	15	10	20	ns
T_{WHQX}	Min	T - x	0.5 T - x	10	8	15	ns
T_{RLAZ}	Max	x	x	0	0	0	ns
T_{WHLH}	Min	T - x	0.5 T - x	15	10	20	ns
T_{WHLH}	Max	T + x	0.5 T + x	15	10	20	ns

14.5.3 External Data Memory Write Cycle

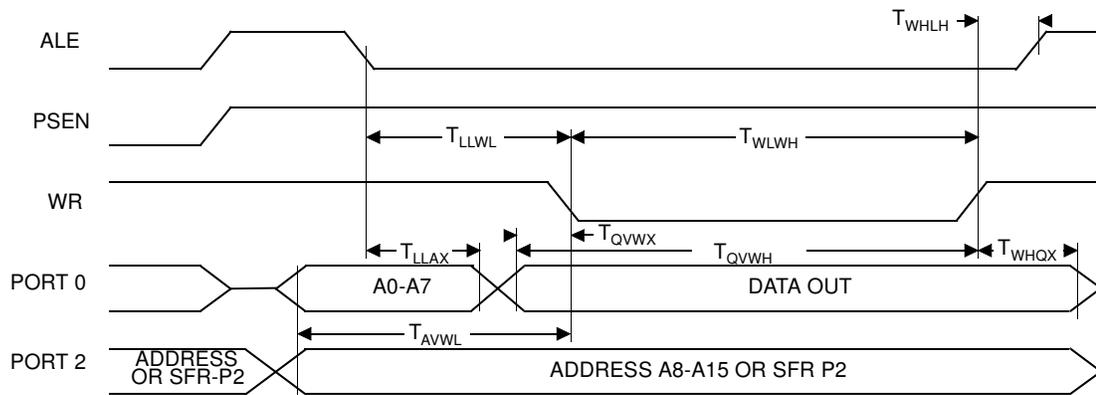


Figure 14-7. External Data Memory Write Cycle

Table 14-13. AC Parameters for a Variable Clock: derating formula

Symbol	Type	Standard Clock	X2 Clock	-M	-V	-L	Units
T_{XLXL}	Min	12 T	6 T				ns
T_{QVXH}	Min	10 T - x	5 T - x	50	50	50	ns
T_{XHGX}	Min	2 T - x	T - x	20	20	20	ns
T_{XHDX}	Min	x	x	0	0	0	ns
T_{XHDV}	Max	10 T - x	5 T - x	133	133	133	ns

14.5.5 Shift Register Timing Waveforms

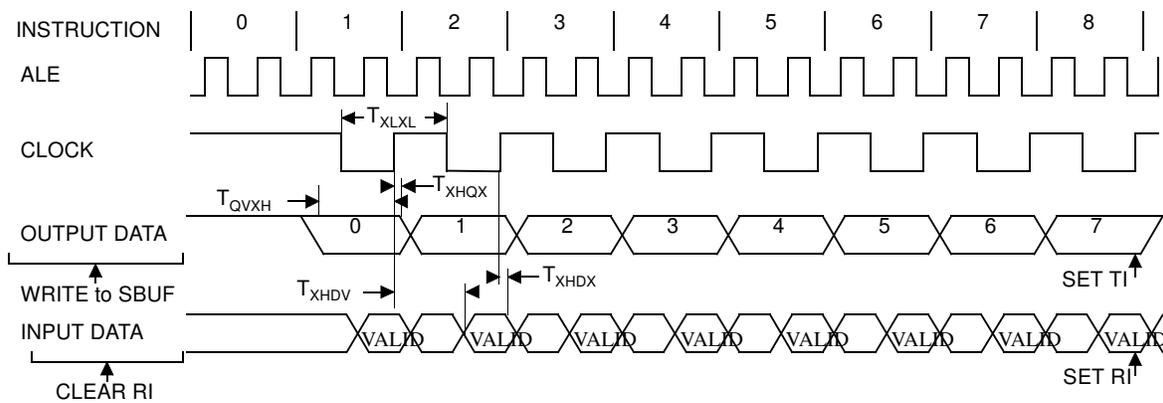
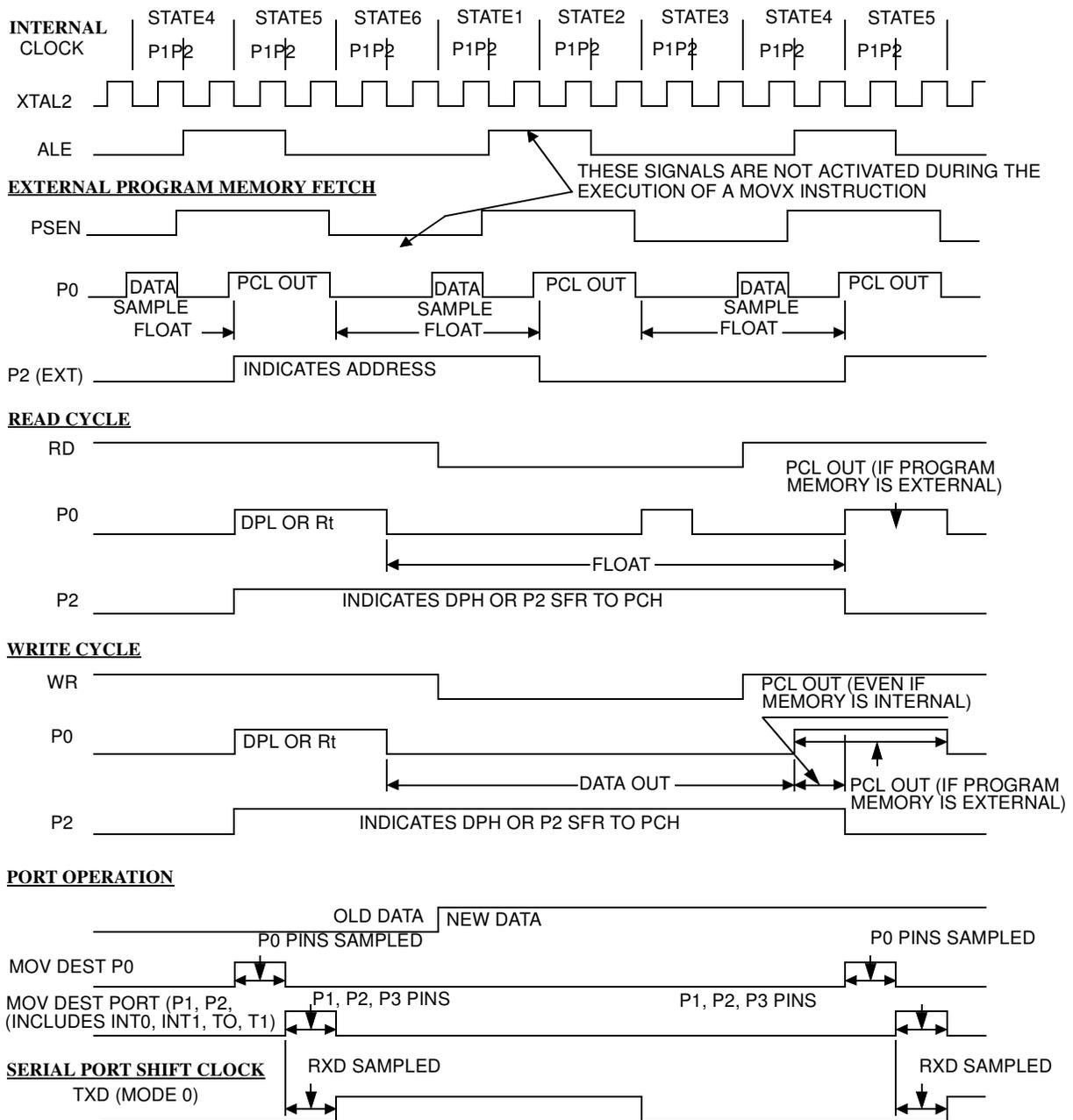


Figure 14-9. Shift Register Timing Waveforms

Table 14-14. External Clock Drive Characteristics (XTAL1)

Symbol	Parameter	Min	Max	Units
T_{CLCL}	Oscillator Period	25		ns
T_{CHCX}	High Time	5		ns
T_{CLCX}	Low Time	5		ns
T_{CLCH}	Rise Time		5	ns
T_{CHCL}	Fall Time		5	ns
T_{CHCX}/T_{CLCX}	Cyclic ratio in X2 mode	40	60	%

Figure 14-13. Clock Waveforms



This diagram indicates when signals are clocked internally. The time it takes the signals to propagate to the pins, however, ranges from 25 to 125 ns. This propagation delay is dependent on variables such as temperature and pin loading. Propagation also varies from output to output and component. Typically though ($T_A=25^\circ\text{C}$ fully loaded) $\overline{\text{RD}}$ and $\overline{\text{WR}}$ propagation delays are approximately 50ns. The other signals are typically 85 ns. Propagation delays are incorporated in the AC specifications.

15. Ordering Information

Part Number ⁽³⁾	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
TS80C31X2-MCA						
TS80C31X2-MCB						
TS80C31X2-MCC						
TS80C31X2-MCE						
TS80C31X2-LCA						
TS80C31X2-LCB						
TS80C31X2-LCC						
TS80C31X2-LCE						
TS80C31X2-VCA						
TS80C31X2-VCB						
TS80C31X2-VCC						
TS80C31X2-VCE						
TS80C31X2-MIA						
TS80C31X2-MIB						
TS80C31X2-MIC						
TS80C31X2-MIE						
TS80C31X2-LIA						
TS80C31X2-LIB						
TS80C31X2-LIC						
TS80C31X2-LIE						
TS80C31X2-VIA						
TS80C31X2-VIB						
TS80C31X2-VIC						
TS80C31X2-VIE						
AT80C31X2-3CSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PDIL40	Stick
AT80C31X2-SLSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PLCC44	Stick
AT80C31X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	VQFP44	Tray
AT80C31X2-3CSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PDIL40	Stick
AT80C31X2-SLSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PLCC44	Stick
AT80C31X2-RLTUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	VQFP44	Tray

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Part Number⁽³⁾	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
AT80C31X2-3CSUV	ROMLess	5V ±10%	Industrial & Green	60 MHz ⁽³⁾	PDIL40	Stick
AT80C31X2-SLSUV	ROMLess	5V ±10%	Industrial & Green	60 MHz ⁽³⁾	PLCC44	Stick
AT80C31X2-RLTUV	ROMLess	5V ±10%	Industrial & Green	60 MHz ⁽³⁾	VQFP44	Tray

- Notes:
1. 20 MHz in X2 Mode.
 2. Tape and Reel available for SL, PQFP and RL packages.
 3. 30 MHz in X2 Mode.



Atmel Corporation

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 487-2600

Regional Headquarters

Europe

Atmel Sarl
Route des Arsenalux 41
Case Postale 80
CH-1705 Fribourg
Switzerland
Tel: (41) 26-426-5555
Fax: (41) 26-426-5500

Asia

Room 1219
Chinachem Golden Plaza
77 Mody Road Tsimshatsui
East Kowloon
Hong Kong
Tel: (852) 2721-9778
Fax: (852) 2722-1369

Japan

9F, Tonetsu Shinkawa Bldg.
1-24-8 Shinkawa
Chuo-ku, Tokyo 104-0033
Japan
Tel: (81) 3-3523-3551
Fax: (81) 3-3523-7581

Atmel Operations

Memory

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 436-4314

Microcontrollers

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 436-4314

La Chantrerie
BP 70602
44306 Nantes Cedex 3, France
Tel: (33) 2-40-18-18-18
Fax: (33) 2-40-18-19-60

ASIC/ASSP/Smart Cards

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Fax: (33) 4-42-53-60-01

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Fax: 1(719) 540-1759

Scottish Enterprise Technology Park
Maxwell Building
East Kilbride G75 0QR, Scotland
Tel: (44) 1355-803-000
Fax: (44) 1355-242-743

RF/Automotive

Theresienstrasse 2
Postfach 3535
74025 Heilbronn, Germany
Tel: (49) 71-31-67-0
Fax: (49) 71-31-67-2340

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Colorado Springs, CO 80906, USA
Tel: 1(719) 576-3300
Fax: 1(719) 540-1759

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38521 Saint-Egreve Cedex, France
Tel: (33) 4-76-58-30-00
Fax: (33) 4-76-58-34-80

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